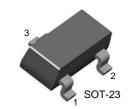


February 2008

## MMBT5770 NPN RF Transistor

- This device is designed for use as RF amplifiers, oscillators and multipliers with collector currents in the 1.0 mA to 30 mA range.
- Sourced from process 43.



1. Base 2. Emitter 3. Collector

### Absolute Maximum Ratings T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V <sub>CBO</sub>	Collector-Base Voltage	30	V	
V <sub>CEO</sub>	Collector-Emitter Voltage	15	V	
V <sub>EBO</sub>	Emitter-Base Voltage	4.5	V	
I <sub>C</sub>	Collector Current - Continuous	10	mA	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C	

### Thermal Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Max.	Units
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	225 1.8	mW mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	556	°C/W

<sup>\*</sup> Device mounted on FR-4PCB 1.6"  $\times$  1.6"  $\times$  0.06".

### Electrical Characteristics Ta=25°C unless otherwise noted

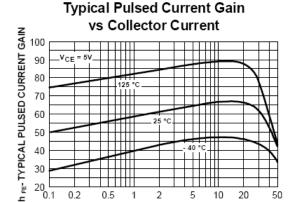
Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Charac	teristics			I.	1
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	Ic = 1.0 μA, Iε = 0	30		V
V <sub>CEO(sus)</sub>	Collector-Emitter Sustaining Voltage*	Ic = 3.0 mA, I <sub>B</sub> = 0	15		V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	3		V
I <sub>CBO</sub>	Collector-Cutoff Current	Vcb = 15 V, IE = 0		50	nA
On Charact	teristics *				
h <sub>FE</sub>	DC Current Gain	$V_{CE} = 1.0V, I_{C} = 3.0mA$	30		
V <sub>CE (sat)</sub>	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 10mA, I <sub>B</sub> = 1.0mA		0.4	V
V <sub>BE (sat)</sub>	Base-Emitter Saturation Voltage	I <sub>C</sub> = 10mA, I <sub>B</sub> = 1.0mA		1.0	V
Small Signa	al Characteristics		•		•
f <sub>T</sub>	Current Gain Bandwidth Product	$I_C = 4.0 \text{mA}, V_{CE} = 10 \text{V}, f = 100 \text{MHz}$	600		MHz

<sup>\*</sup> Pulse Test: Pulse Width $\leq$ 300 $\mu$ s, Duty Cycle $\leq$ 2%

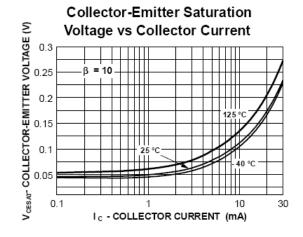
### **Typical Characteristics**

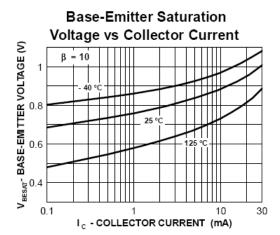
20 L 0.1

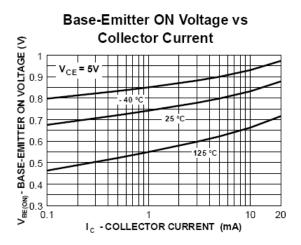
0.2

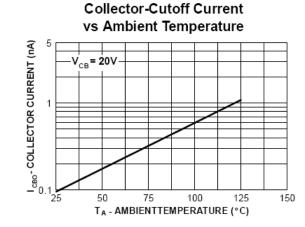


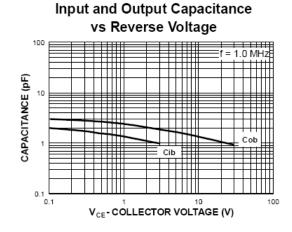
Ic - COLLECTOR CURRENT (mA)



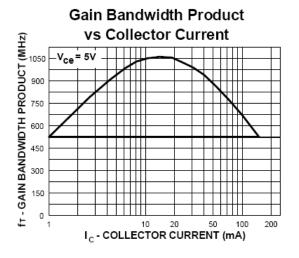




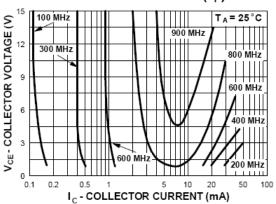




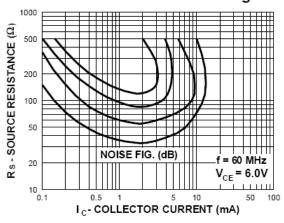
### **Typical Characteristics** (continued)



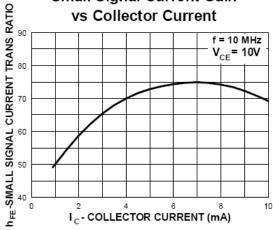
## **Contours of Constant Gain** Bandwidth Product (f<sub>T</sub>)



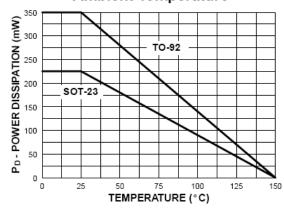
### **Contours of Constant Noise Figure**



# **Small Signal Current Gain**

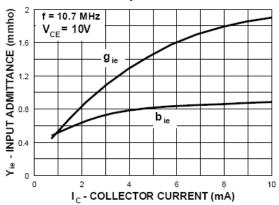


### Power Dissipation vs Ambient Temperature

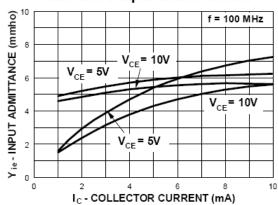


### Typical Characteristics (continued)

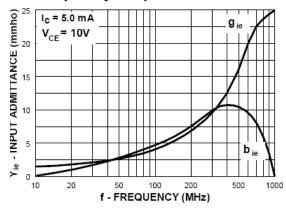
## Input Admittance vs Collector **Current-Output Short Circuit**



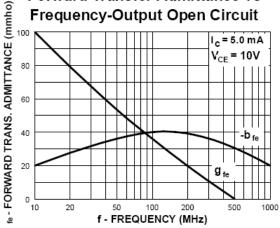
### Input Admittance vs Collector **Current-Output Short Circuit**



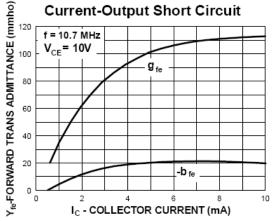
### Input Admittance vs Frequency-Output Short Circuit



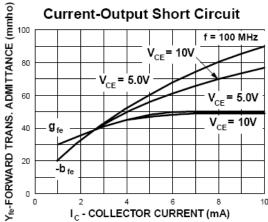
### Forward Transfer Admittance vs Frequency-Output Open Circuit



## Forward Trans. Admittance vs Collector

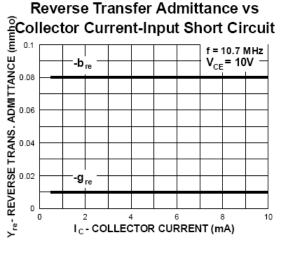


## Forward Trans. Admittance vs Collector

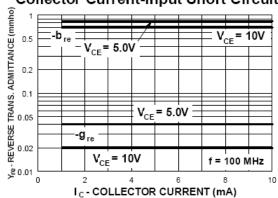


### **Typical Characteristics** (continued)

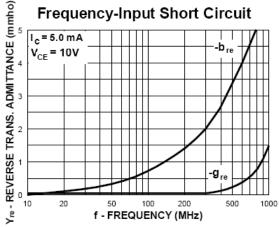
# Reverse Transfer Admittance vs



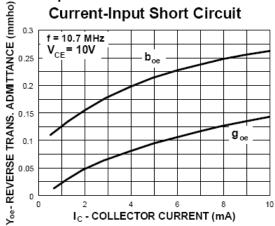
### Reverse Transfer Admittance vs Collector Current-Input Short Circuit



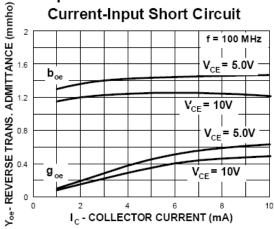
## Reverse Transfer Admittance vs Frequency-Input Short Circuit



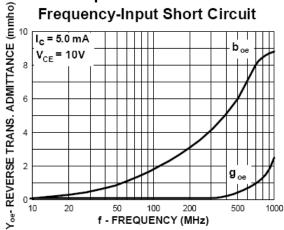
### Output Admittance vs Collector **Current-Input Short Circuit**



### Output Admittance vs Collector Current-Input Short Circuit



### Output Admittance vs Frequency-Input Short Circuit







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